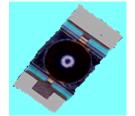


DATASHEET

1.6mm Round Subminiature Chip LED EAIST3216A1



Features

- Small double-end package
- Low forward voltage
- Good spectral matching to Si photo detector
- Package in 8mm tape on 7" diameter reel.
- Pb free
- The product itself will remain within RoHS compliant version.

Descriptions

• EAIST3216A1 is an infrared emitting diode

in miniature SMD package which is molded in a water clear plastic with spherical top view lens.

The device is spectrally matched with silicon photodiode and phototransistor

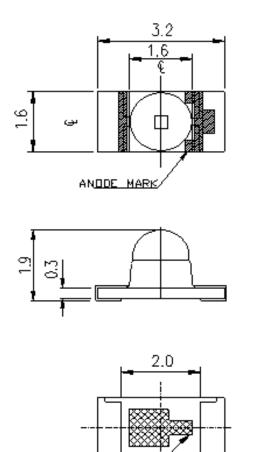
Applications

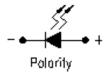
- PCB mounted infrared sensor
- Infrared remote control units with high power requirement
- Scanner
- Infrared applied system

Device Selection Guide

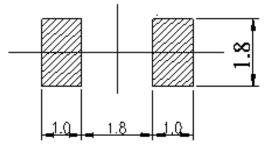
Part Category	Chip Material	Resin Color	
EAIST3216A1	GaAlAs	Black	

Package Dimensions





For Reflow Soldering



Notes: 1.All dimensions are in millimeters 2.Tolerances unless dimensions ±0.1mm

ANDIE MARK

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Continuous Forward Current	$I_{\rm F}$	50	mA
Peak Forward Current *1	I _{FP}	500	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C
Soldering Temperature *2	T _{sol}	260	°C
Power Dissipation at(or below)	P _d	130	mW
25°C Free Air Temperature			

Notes: *1:I_{FP} Conditions--Pulse Width $\leq 100 \,\mu$ s and Duty $\leq 1\%$.

*2:Soldering time \leq 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
		I _F =20mA	10	20		
Radiant Intensity	Ie	$I_F=70mA$ Pulse Width=100 μ s		75		mW /sr
Peak Wavelength	λp	I _F =20mA		850		nm
Spectral Bandwidth	Δλ	I _F =20mA		30		nm
Forward Voltage	V _F	I _F =20mA	1.20	1.45	1.70	V
		$I_F=70mA$ Pulse Width=100 μ s	1.40	1.60	2.00	
Reverse Current	I _R	V _R =5V			10	μA
View Angle	$2 \theta 1/2$	I _F =20mA		20		deg

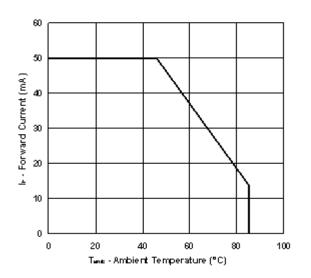
Data Sheet 1.6mm Round Subminiature Chip LED EAIST3216A1

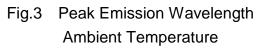
Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs.

Fig.2 Spectral Distribution

Ambient Temperature





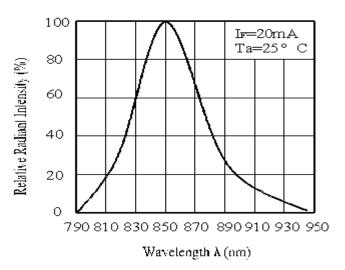
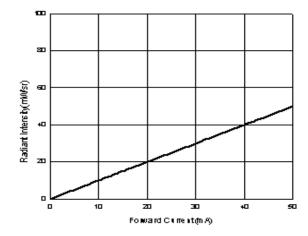
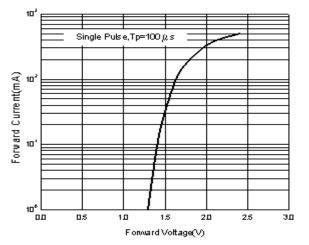


Fig.4 Forward Current vs. Forward Voltage



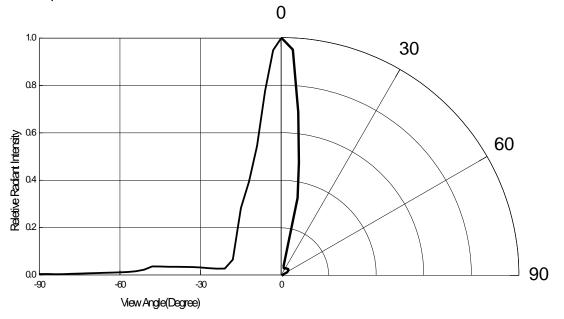


Data Sheet 1.6mm Round Subminiature Chip LED EAIST3216A1

Typical Electro-Optical Characteristics Curves

Fig.5 Relative Radiant Intensity vs.

Angular Displacement



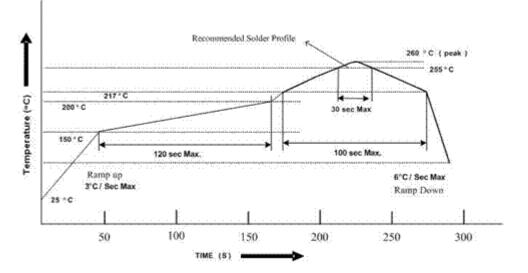
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big

current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30 $^\circ\!C$ or less and 90%RH or less.
 - 2.3 The LEDs should be used within a year.
 - 2.4 After opening the package, the LEDs should be kept at 30° C or less and 60%RH or less.
 - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
 - 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment : 60±5°C for 48 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

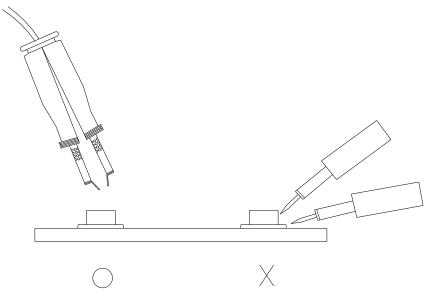
Data Sheet 1.6mm Round Subminiature Chip LED EAIST3216A1

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

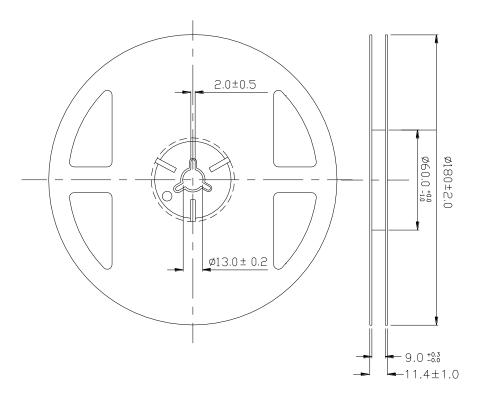
5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

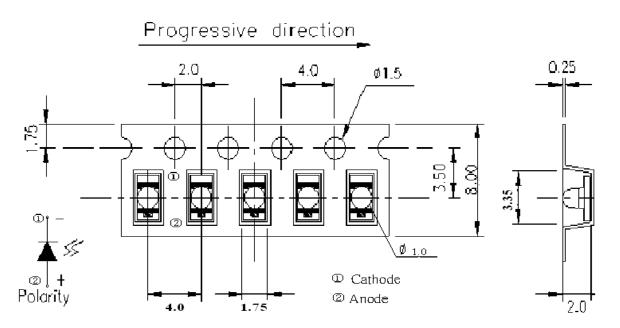




Reel Dimensions

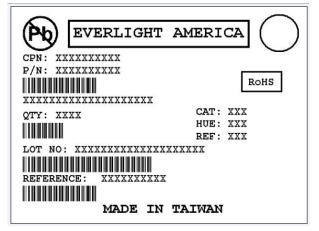


Carrier Tape Dimensions: Loaded quantity 1500 PCS per reel :



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Label Form Specification



CPN: Customer's Production Number P/N : Production Number QTY: Packing Quantity CAT: Ranks HUE: Peak Wavelength REF: Reference LOT No: Lot Number

Notes

- 1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 3. These specification sheets include materials protected under copyright of Everlight Americas corporation. Please don't reproduce or cause anyone to reproduce them without Everlight Americas's consent.